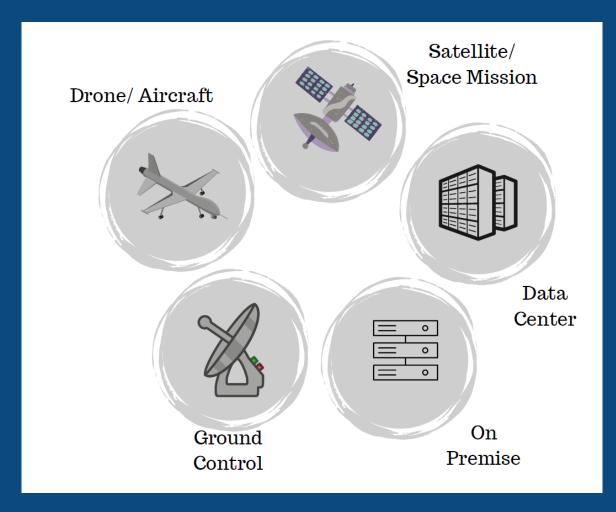






NSF-Crosstalk Phase I Updates

- Mission and objectives:
 - Dual-use AI accelerator/Big data analytics chip design
 - Demonstrate proof-of-concept at 28nm
 - Develop a software interface to communicate with the chip
 - Benchmark against state-of-the-art for computer vision application (i.e., ResNet-50)
- Recent Updates
 - NSF Phase I ended
 - Pending proposals and incubations



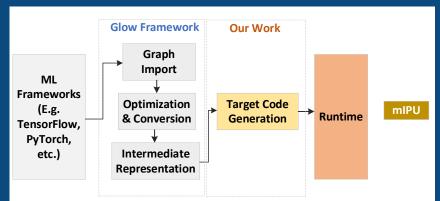


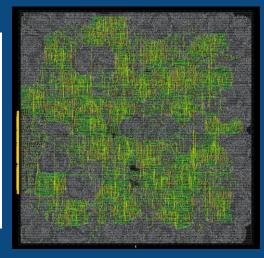


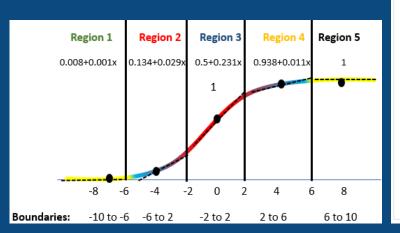


High-Level Overview of the Program:

- Develop chip design flow to go from RTL to GDSII.
- Optimization for Area, Power, and Performance.
- Integrate embedded memory from TSMC.
- Develop software interpreter to interface with Open-Source Compilers.
- Explore commercialization opportunities.
 - NDA: <u>Qualcomm, TactComputeLab, NAG,</u>
 HP, InAccel















Program Summary

- Sponsor: NSF
- Funding: \$256K
- Number of staff/faculty/students:
 - Staff 1
 - Faculty 2
 - Students 1
- Major milestones remaining:
 - Finalize GDS II with optimized power and performance
 - Test the chip
 - Identify customers and commercialization pathway



(MIDE/ECE)



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Arif Igbal (Crosstalk/Arithmik)



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• Timeline for project: 01FEB21 – 31DEC22